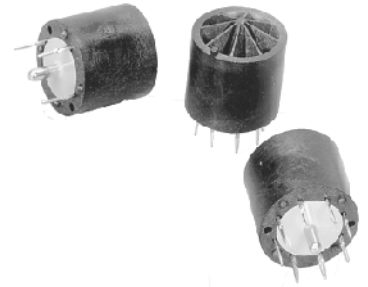




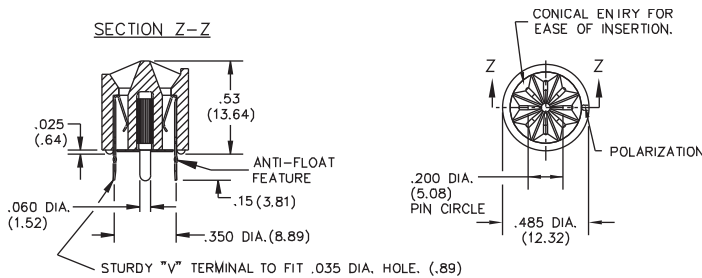
# 611/612 SERIES FOR TO PIN CIRCLE DEVICES

## 611 Series for TO-5 .200" Diameter Pin Circle Devices

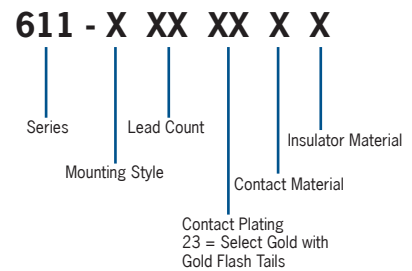
- Molded guides prevent “stubbing” of device leads
- Low-Insertion force contacts with large target area
- Retention feature on the tails
- Polarized to BIB, not to device
- Center hold down pin
- For temperatures up to 150°C



Rated for 5,000 Cycles



### DESCRIPTION & ORDERING INFORMATION

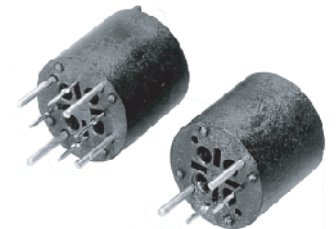


Accepts package pin diameter of 0.018+/-0.005 inches

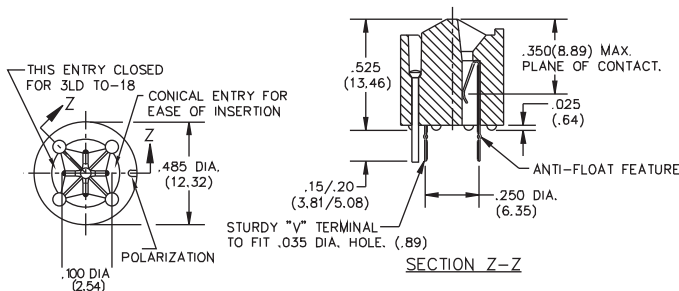
Lead Count	Contact Material	Contact Plating	Plating Thickness	Part Number
3	Beryllium Copper	Select Gold	30 microinches	611-1032314
4	Beryllium Copper	Select Gold	30 microinches	611-1042314
8	Beryllium Copper	Select Gold	30 microinches	611-1082314
10	Beryllium Copper	Select Gold	30 microinches	611-1102314

## 612 Series for TO-18 .100" Diameter Pin Circle Devices

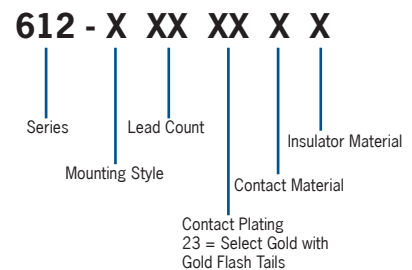
- Low-Insertion force
- Large entry area for easy insertion of device leads
- Polarized to BIB, not to device
- Four solder hold down pins
- For temperatures up to 150°C



Rated for 5,000 Cycles



### DESCRIPTION & ORDERING INFORMATION



Accepts package pin diameter of 0.018+/-0.005 inches

Lead Count	Contact Material	Contact Plating	Plating Thickness	Part Number
3	Beryllium Copper	Select Gold	30 microinches	612-1032314
4	Beryllium Copper	Select Gold	30 microinches	612-1042314